EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	("6807064").URPN.	USPAT	OR	ON	2007/03/15 20:11
L2	13	("20020034872" | "5111279" | "5384952" | "5477160" | "5700715" | "5783465" | "5874782" | "5920125" | "5985682" | "6084781" | "6277669" | "6281452" | "6284563").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 20:33
L3	2	09/925374	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 20:22
L4	4	("6639315").URPN.	USPAT	OR	ON	2007/03/15 20:22
L5	3	("5148265" | "6049128" | "6130112").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 20:24
L10	0	jp5144823a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:40
L11	0	jp50144823a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:40
L12	0	jp05144823a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:40
L13	2	de19832706a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:41
S67 2	1	jp2004193456a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:35

S67 3	7	"6441500"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:35
S67 4	2	"6339251"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:35
S67 5	6	"6495916"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:35
S67 6	15	S673 S674 S675	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:39
S67 7	0	de10105351a1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:39
S67 8	1	de10105351a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:39
S67 9	264	HEDLEND-HARRY-A HEDLER-H HEDLER-HARRY HEDLER-HARRY-DR HEDLER-HARRY-DR-DIPL-PHYS	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:43
S68 0	230	S679 and (chip die device electronic semiconductor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:44

EAST Search History

S68 1	116	S680 and (board leadframe (lead adj frame))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 14:44
S68 2	18	("20020090761" | "20020140081" | "20030030143" | "20030096518" | "20050070049" | "4748495" | "5400950" | "5781415" | "5796169" | "5908333" | "5947753" | "5981310" | "6012224" | "6130116" | "6238938" | "6562637" | "6717819" | "6848173"). PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 14:47
S68 3	0	("6979591").URPN.	USPAT	OR	ON	2007/03/15 14:50
S68 4	18	("20020121706" | "20020130412" | "20030038355" | "20030067755" | "4818728" | "5214308" | "5328087" | "5477087" | "5598033" | "5646828" | "5801446" | "5898223" | "6077723" | "6239983" | "6335571" | "6462420" | "6822317" | "6885106").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 14:50
S68 5	0	("6919232").URPN.	USPAT	OR	ON	2007/03/15 14:56
S68 6	8	("4927740" | "5212387" | "5998243" | "6043564" | "6177725" | "6429043" | "6448633" | "6507092").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 14:56

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	0	("6807064").URPN.	USPAT	OR	ON	2007/03/15 20:11
L2	13	("20020034872" | "5111279" | "5384952" | "5477160" | "5700715" | "5783465" | "5874782" | "5920125" | "5985682" | "6084781" | "6277669" | "6281452" | "6284563").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 20:33
L3	2	09/925374	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 20:22
L4	4	("6639315").URPN.	USPAT	OR	ON	2007/03/15 20:22
L5	3	("5148265" | "6049128" | "6130112").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 20:24
L10	0	jp5144823a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:40
L11	0	jp50144823a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:40
L12	0	jp05144823a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:40
L13	2	de19832706a	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 20:41
L14	3130	257/e23.021.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 21:01

L15	2570	257/e23.124.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 21:01
L16	5618	14 15	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 21:01
L17	391	16 and elastomer$2 and (electronic wafer chip die)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 21:03
L18	357	17 and (etch$3 remove$1 removing)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 21:03
L19	100	18 and ((contact electrode connection) with protrud$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 21:04
L20	107	18 and ((contact terminal electrode connection) with protrud$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/03/15 21:04
L21	0	("6927489").URPN.	USPAT	OR	ON	2007/03/15 21:13
L22	1	("6051450").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/03/15 21:13